



Silicon PIN Photodiode

VEMD2520X01



16758-11

VEMD2500X01



FEATURES

- Package type: surface mount
- Package form: GW, RGW
- Dimensions (L x W x H in mm): 2.3 x 2.3 x 2.8
- AEC-Q101 qualified
- High radiant sensitivity
- Suitable for visible and near infrared radiation
- Fast response times
- Angle of half sensitivity: $\phi = \pm 15^\circ$
- Package matched with IR emitter series VSMB2000X01
- Floor life: 4 weeks, MSL 2a, acc. J-STD-020
- Lead (Pb)-free reflow soldering
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC



DESCRIPTION

VEMD2500X01 and VEMD2520X01 are high speed and high sensitive PIN photodiodes in a clear epoxy, miniature surface mount package (SMD) with dome lens. The photo sensitive area of the chip is 0.23 mm².

Note

** Please see document "Vishay Material Category Policy":
www.vishay.com/doc?99902

APPLICATIONS

- High speed photo detector

PRODUCT SUMMARY

| COMPONENT | I_{ra} (μA) | ϕ (deg) | $\lambda_{0.1}$ (nm) |
|-------------|---------------|--------------|----------------------|
| VEMD2500X01 | 12 | ± 15 | 350 to 1120 |
| VEMD2520X01 | 12 | ± 15 | 350 to 1120 |

Note

- Test conditions see table "Basic Characteristics"

ORDERING INFORMATION

| ORDERING CODE | PACKAGING | REMARKS | PACKAGE FORM |
|---------------|---------------|------------------------------|------------------|
| VEMD2500X01 | Tape and reel | MOQ: 6000 pcs, 6000 pcs/reel | Reverse gullwing |
| VEMD2520X01 | Tape and reel | MOQ: 6000 pcs, 6000 pcs/reel | Gullwing |

Note

- MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25^\circ\text{C}$, unless otherwise specified)

| PARAMETER | TEST CONDITION | SYMBOL | VALUE | UNIT |
|-------------------------------------|-----------------------------------|------------|---------------|------------------|
| Reverse voltage | | V_R | 60 | V |
| Power dissipation | $T_{amb} \leq 25^\circ\text{C}$ | P_V | 215 | mW |
| Junction temperature | | T_j | 100 | $^\circ\text{C}$ |
| Operating temperature range | | T_{amb} | - 40 to + 100 | $^\circ\text{C}$ |
| Storage temperature range | | T_{stg} | - 40 to + 100 | $^\circ\text{C}$ |
| Soldering temperature | Acc. reflow solder profile fig. 7 | T_{sd} | 260 | $^\circ\text{C}$ |
| Thermal resistance junction/ambient | Acc. J-STD-051 | R_{thJA} | 250 | K/W |

**BASIC CHARACTERISTICS** ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

| PARAMETER | TEST CONDITION | SYMBOL | MIN. | TYP. | MAX. | UNIT |
|----------------------------------|---|-----------------|------|-------------|------|---------------|
| Forward voltage | $I_F = 50\text{ mA}$ | V_F | | 1 | | V |
| Breakdown voltage | $I_R = 100\text{ }\mu\text{A}$, $E = 0$ | $V_{(BR)}$ | 32 | | | V |
| Reverse dark current | $V_R = 10\text{ V}$, $E = 0$ | I_{ro} | | 1 | 10 | nA |
| Diode capacitance | $V_R = 0\text{ V}$, $f = 1\text{ MHz}$, $E = 0$ | C_D | | 4 | | pF |
| | $V_R = 5\text{ V}$, $f = 1\text{ MHz}$, $E = 0$ | C_D | | 1.3 | | pF |
| Open circuit voltage | $E_e = 1\text{ mW/cm}^2$, $\lambda = 950\text{ nm}$ | V_o | | 350 | | mV |
| Temperature coefficient of V_o | $E_e = 1\text{ mW/cm}^2$, $\lambda = 950\text{ nm}$ | TK_{V_o} | | - 2.6 | | mV/K |
| Short circuit current | $E_e = 1\text{ mW/cm}^2$, $\lambda = 950\text{ nm}$ | I_k | | 11 | | μA |
| Temperature coefficient of I_k | $E_e = 1\text{ mW/cm}^2$, $\lambda = 950\text{ nm}$ | TK_{I_k} | | 0.1 | | %/K |
| Reverse light current | $E_e = 1\text{ mW/cm}^2$, $\lambda = 950\text{ nm}$, $V_R = 5\text{ V}$ | I_{ra} | 8.5 | 12 | 17 | μA |
| Angle of half sensitivity | | ϕ | | ± 15 | | deg |
| Wavelength of peak sensitivity | | λ_p | | 900 | | nm |
| Range of spectral bandwidth | | $\lambda_{0.1}$ | | 350 to 1120 | | nm |
| Rise time | $V_R = 10\text{ V}$, $R_L = 1\text{ k}\Omega$, $\lambda = 820\text{ nm}$ | t_r | | 100 | | ns |
| Fall time | $V_R = 10\text{ V}$, $R_L = 1\text{ k}\Omega$, $\lambda = 820\text{ nm}$ | t_f | | 100 | | ns |

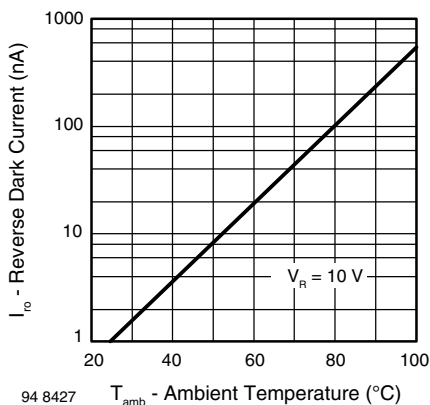
BASIC CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

Fig. 1 - Reverse Dark Current vs. Ambient Temperature

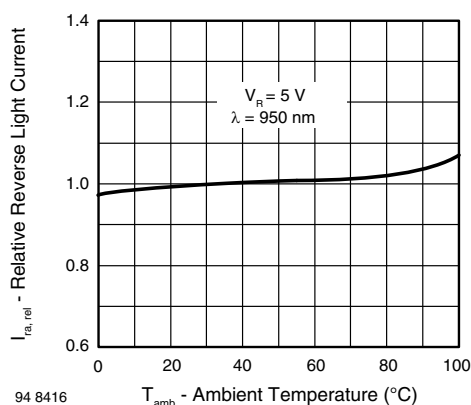


Fig. 2 - Relative Reverse Light Current vs. Ambient Temperature

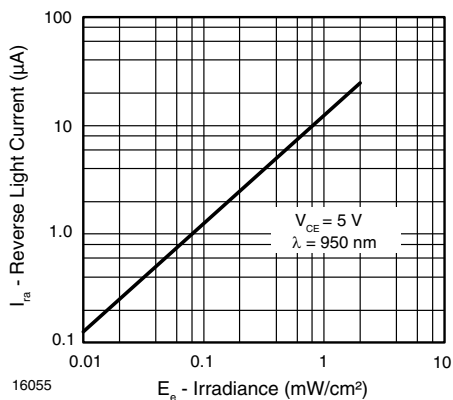


Fig. 3 - Reverse Light Current vs. Irradiance

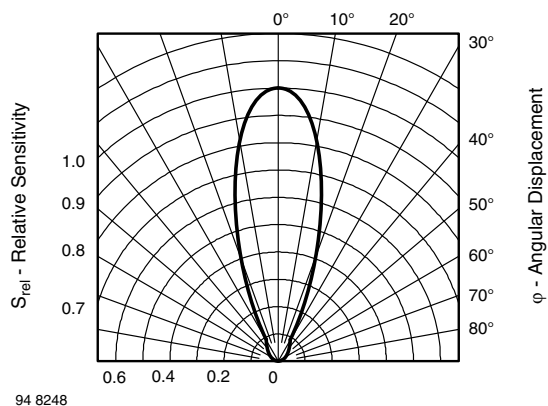


Fig. 6 - Relative Radiant Sensitivity vs. Angular Displacement

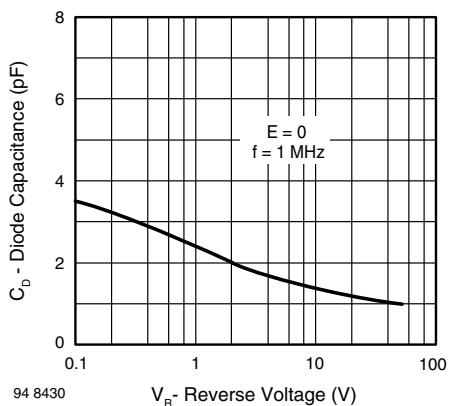


Fig. 4 - Diode Capacitance vs. Reverse Voltage

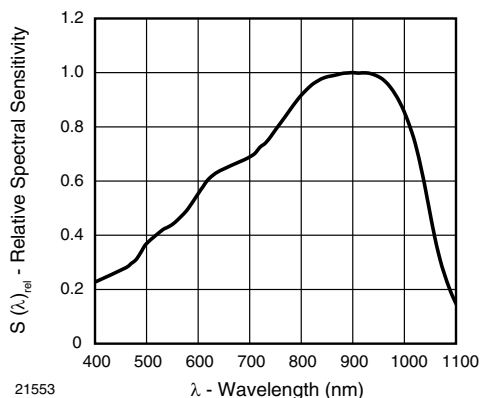


Fig. 5 - Relative Spectral Sensitivity vs. Wavelength

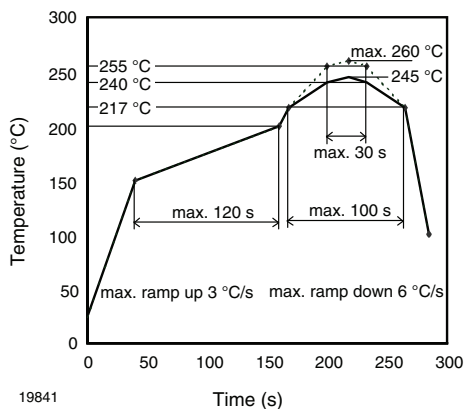
**REFLOW SOLDER PROFILE**

Fig. 7 - Lead (Pb)-free Reflow Solder Profile acc. J-STD-020D

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

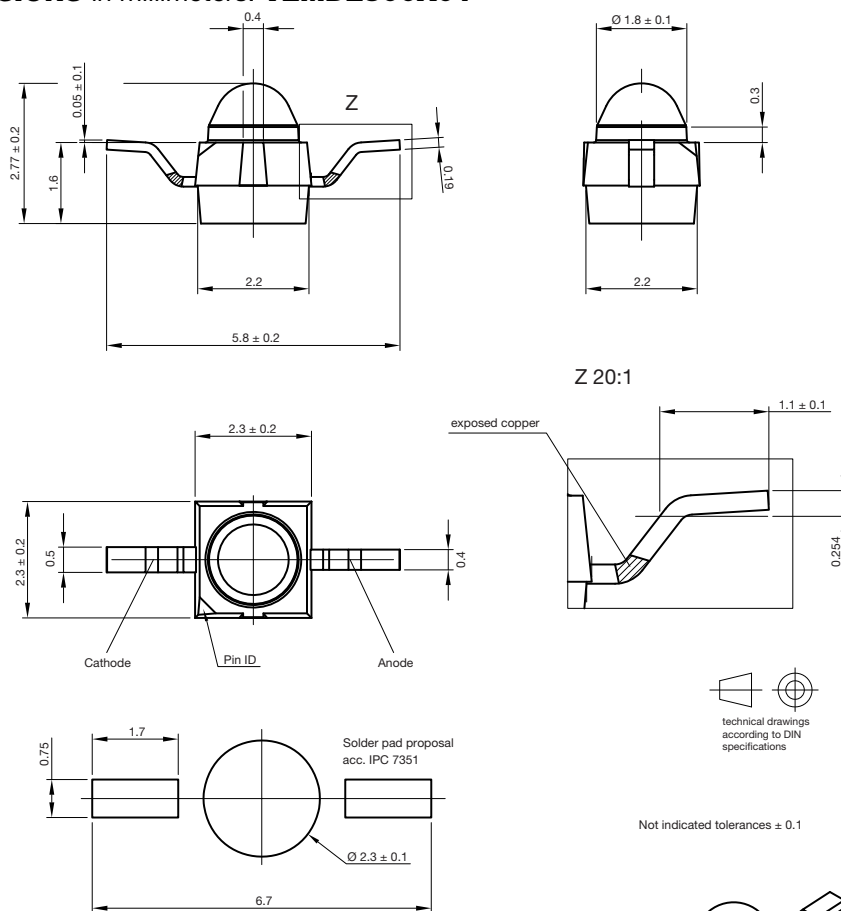
Floor life: 4 weeks

Conditions: $T_{amb} < 30\text{ °C}$, RH < 60 %

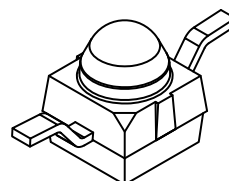
Moisture sensitivity level 2a, acc. to J-STD-020.

DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 °C (+ 5 °C), RH < 5 %.

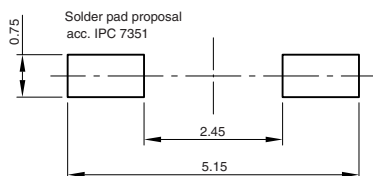
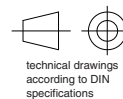
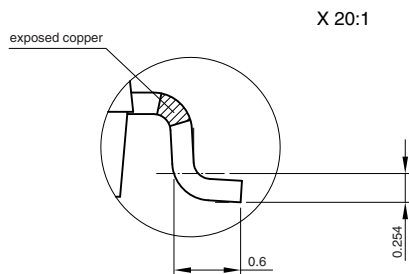
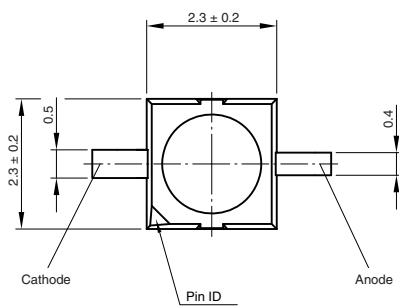
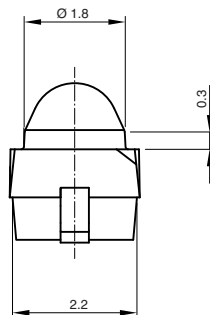
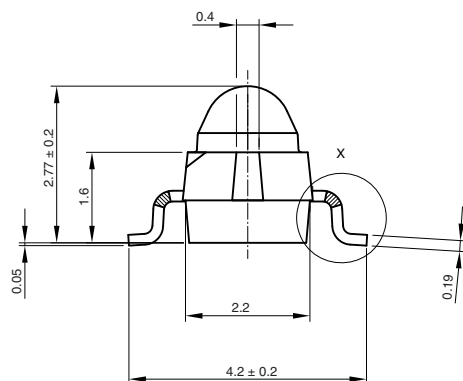
PACKAGE DIMENSIONS in millimeters: **VEMD2500X01**

Drawing-No.: 6.544-5391.02-4
Issue: 2; 18.03.10
21517

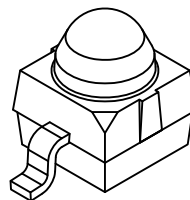




PACKAGE DIMENSIONS in millimeters: VEMD2520X01

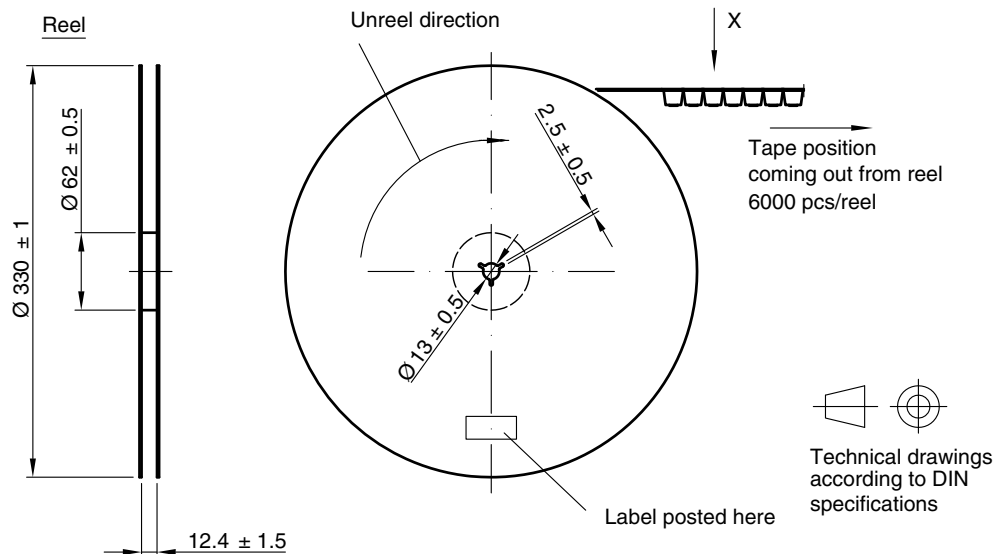


Not indicated tolerances ± 0.1

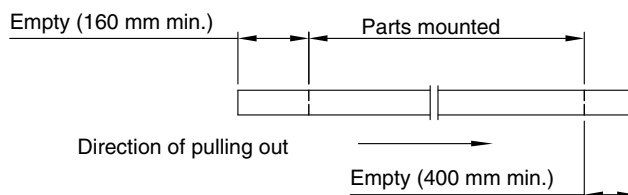


Drawing-No.: 6.544-5383.02-4
Issue: 4; 18.03.10
21488

TAPING AND REEL DIMENSIONS in millimeters: **VEMD2500X01**

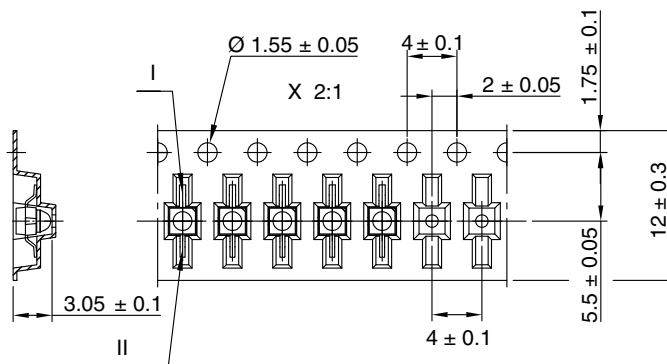


Leader and trailer tape:

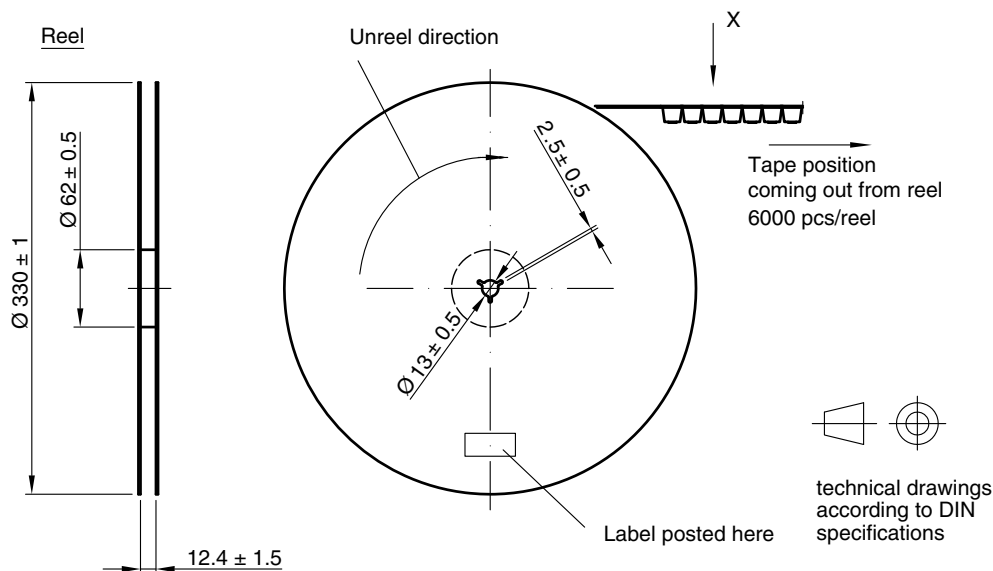
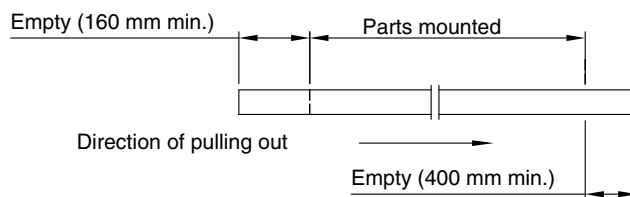


Terminal position in tape

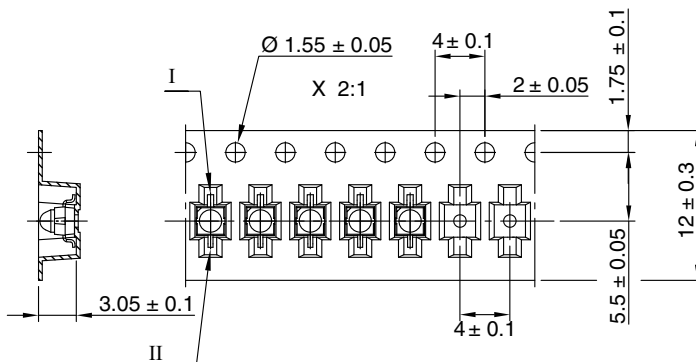
| Device | Lead I | Lead II |
|------------|-----------|---------|
| VEMT2000 | Collector | Emitter |
| VEMT2500 | | |
| VEMD2000 | Cathode | Anode |
| VEMD2500 | | |
| VSMB2000 | | |
| VSMG2000 | Anode | Cathode |
| VSMY2850RG | | |



Drawing-No.: 9.800-5100.01-4
Issue: 2; 18.03.10
21572

TAPING AND REEL DIMENSIONS in millimeters: **VEMD2520X01**

Leader and trailer tape:

Terminal position in tape

| Device | Lead I | Lead II |
|-----------|-----------|---------|
| VEMT2020 | Collector | Emitter |
| VEMT2520 | | |
| VSMB2020 | Cathode | Anode |
| VSMG2020 | | |
| VEMD2020 | | |
| VEMD2520 | Anode | Cathode |
| VSMY2850G | | |



Drawing-No.: 9.800-5091.01-4

Issue: 3; 18.03.10

21571



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